

L Number	Hits	Search Text	DB	Time stamp
22	3	(led or (light adj emitting adj diode)) and ((elliptical or dome or rounded) adj (encapsulant or encapsulation))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/19 18:23
23	8	((elliptical or dome or rounded) adj (encapsulant or encapsulation))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/19 18:22
24	5	((circular or oval) adj (encapsulant or encapsulation))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/19 18:45
26	766	(led or (light adj emitting adj diode)) adj (recess or groove or opening)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/19 18:36
27	163	(led or (light adj emitting adj diode)) and 257/787.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/19 18:43
28	112	(led or (light adj emitting adj diode)) and 257/773.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/19 18:43
29	114	(encapsulant or encapsulation) and 257/773.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/19 18:50
30	57	(encapsulant or encapsulation) and 257/773.ccls. and (recess or groove or opening)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/19 18:51
31	25	(encapsulant or encapsulation) and 257/622.ccls. and (recess or groove or opening)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/19 18:52
32	7	(encapsulant or encapsulation) and 257/618.ccls. and (recess or groove or opening)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/19 18:53
33	188	(encapsulant or encapsulation) and 257/678.ccls. and (recess or groove or opening)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/19 19:00
34	1	(encapsulant or encapsulation) and 257/594.ccls. and (recess or groove or opening)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/19 19:01
35	92	257/594.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/19 19:49
36	2	6069440.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/19 19:19

37	2	5407502.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/19 19:19
38	1801	257/774.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/19 19:50
39	135	257/774.ccls. and (encapsulant or encapsulation)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/19 19:50